PCN	Number:		201	6020200	1			PCN Date: 0	02/05/2016
Title	Qua Dev		of AS	SEN as Ad	ditional Assemb	y and Te	st Site	for Select UQFI	N Package
Cust	omer Con	tact:	PCN /	<u>Manager</u>	Dept:	Quality	' Servi	ces	
Prop	Proposed 1 st Ship Date: 05/05/2016 Estimated Sample Availability: Date Provided at Sample request								
Chan	Change Type:								
	Assembly	Site			Design			Wafer Bump	Site
	Assembly	Process	;		Data Sheet			Wafer Bump Material	
	Assembly	Materia	ls		Part number	change		Wafer Bump	Process
	Mechanica	l Specif	ication		Test Site			Wafer Fab Sit	te
\boxtimes	Packing/S	hipping,	/Labelii	ng	Test Process			Wafer Fab Ma	aterials
								Wafer Fab Pro	ocess
					PCN Deta	ils			
Desc	ription of	Chang	e:						
and 1	Test Site fo Material dif	r select	device	es listed i	n the "Product A			EN as Additional n. Current asse	
	embly Site	Assen		e Origin	Assembly Cour	try Code	As	ssembly Site City	/
	UTAC		NSE		TH			Bangkok	
	JCET		JCE		CN			Jiangyin	
	HANA		HNT		TH			Ayutthaya	
	ASEN		ASN		CN			Suzhou	
Material Differences:							ASEN	I	
				I I A C	1 1CFT	ΗΛ	NA		
Me	ount Comp	ound		TAC	JCET		NA 172		
	ount Comp		PZ	20037	12040200160	0 400	173	1400238112	
	lold Compo	ound	PZ CZ	20037 20136	12040200160 12090300370	0 400 9 450	173 176	1400238112 1801512111	
Test test f	Lead finis coverage, MQ.	ound sh insertio	PZ CZ Ni	20037 20136 PdAu	12040200160 12090300370 NiPdAu	0 400 9 450 NiPd	173 176 AuAg	1400238112	erified with
Test test f	Lead finis	ound sh insertio	PZ CZ Ni	20037 20136 PdAu	12040200160 12090300370 NiPdAu	0 400 9 450 NiPd	173 176 AuAg	1400238112 1801512111 NiPdAu	erified with
Test test N Reas Conti	Lead finis coverage, MQ. son for Ch	ound sh insertion ange: upply.	PZ CZ Ni ns, con	20037 20136 PdAu nditions w	12040200160 12090300370 NiPdAu ill remain consis	9 400 9 450 NiPd	173 176 AuAg currei	1400238112 1801512111 NiPdAu nt testing and v	
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Sample product shipping label (not actual product label)

TEXAS INSTRUMENTS

MADE IN: Malaysia 2DC: 2Q:

MSL 2 /260C/1 YEAR SEAL DT MSL 1 /235C/UNLIM 03/29/04

OPT: ITEM:

5A (L)T0:3750



(1P) SN74LS07NSR (Q) 2000 (D) 0336 (31T)LOT: 3959047MLA (4W) TKY(1T) 7523483SI2

(2P) REV: (V) 0033317 (20L) CSO: SHE (21L) CCO:USA (22L) ASO: MLA (23L) ACO: MYS

Product Affected:

SN74AVC2T245RSWR	TPD13S523RSVR	TS3USB221RSER	TXB0104RUTR
SN74AVC4T245RSVR	TPD6E001RSER	TS3USB30ERSWR	TXB0304RUTR
SN74AVC4T774RSVR	TS3USB221ARSER	TS5A23159RSER	
TCA6408ARSVR	TS3USB221ERSER	TS5USBA224RSWR	

Qualification Report

ASEN RSE Package (Hong-how HP20VI-RH screen print)

Qualification Approved on 1/21/2016

Product Attributes

Attributes	Qual Device: TS3USB221ERSER	QBS Product Reference: TS3USB221ARSE	QBS Product Reference: TS3USB221EDRC	QBS Package Reference: SN74AVC4T245RSVR
Assembly Site	ASEN	NSE	TIM (MAL)	ASEN
Package Family	QFN	QFN	QFN	-
Flammability Rating	UL 94 V-0	UL 94 V-0	UL 94 V 0	UL 94 V-0
Wafer Fab Supplier	FFAB	FFAB	FFAB	FFAB
Wafer Process	50B10	50b10.13	50B10.13	ASLC10

- QBS: Qual By Similarity
- Qual Devices qualified at LEVEL1-260C: TS3USB221RSER, TS3USB221ERSER
- Qual Devices qualified at LEVEL1-260CG: TS3USB221ARSER, TS5A23159RSER

Qualification Results

Data Displayed as: Number of lots / Total sample size / Total failed

Туре	Test Name / Condition	Duration	Qual Device: TS3USB221ERSER	QBS Product Reference: TS3USB221ARSE	QBS Product Reference: TS3USB221EDRC	QBS Package Reference: SN74AVC4T245RSVR
AC	Autoclave 121C	96 Hours	-	3/231/0	-	3/231/0
ED	Electrical Characterization	Per Datasheet Parameters	-	Pass	Pass	Pass
FLAM	Flammability (IEC 695-2-2)	1	-	-	-	3/15/0
FLAM	Flammability (UL 94V-0)	1	-	-	-	3/15/0
FLAM	Flammability (UL-1694)		-	-	-	3/15/0
HAST	Biased HAST, 130C/85%RH	96 Hours	-	3/231/0	-	3/231/0
HBM	ESD - HBM	7000 V	-	3/9/0	1/3/0	-
HBM	ESD - HBM -HIGH	12000 V	-	3/9/0	-	-
CDM	ESD - CDM	1500 V	-	3/9/0	1/3/0	-
HTOL	Life Test, 150C	300 Hours	-	3/348/0	-	3/231/0
HTSL	High Temp. Storage Bake, 170C	420 Hours	-	-	-	3/231/0
HTSL	High Temp. Storage Bake, 150C	1000 Hours	-	3/231/0	-	-
LU	Latch-up	(per JESD78)	-	3/9/0	1/6/0	-
PD	Physical Dimensions		3/15/0	-	-	3/15/0
SD	Solderability	Pb Free	-	-	-	3/66/0
TC	Temperature Cycle, - 65/150C	500 Cycles	-	3/231/0	-	3/231/0
WBP	Bond Strength	Wires	3/228/0	-	-	3/228/0

- Preconditioning was performed for Autoclave, Unbiased HAST, THB/Biased HAST, Temperature Cycle, Thermal Shock, and HTSL, as applicable
- The following are equivalent HTOL options based on an activation energy of 0.7eV : 125C/1k Hours, 140C/480 Hours, 150C/300 Hours, and 155C/240 Hours
- The following are equivalent HTSL options based on an activation energy of 0.7eV: 150C/1k Hours, and 170C/420 Hours
- The following are equivalent Temp Cycle options per JESD47 : -55C/125C/700 Cycles and -65C/150C/500 Cycles

Quality and Environmental data is available at Tl's external Web site: http://www.ti.com/

Green/Pb-free Status:

Qualified Pb-Free(SMT) and Green

Qualification Report

ASEN RSV Package (Hong-how HP20VI-RH screen print)

Qualification Approved on 1/21/2016

Product Attributes

Attributes	Qual Device: SN74AVC4T245RSVR	QBS Product Reference: SN74AVC4T245PWR	QBS Product Reference: TCA6408APWR
Assembly Site	ASEN	MLA	TIM
Package Family	-	TSSOP	TSSOP
Flammability Rating	UL 94 V-0	UL 94 V-0	UL 94 V-0
Wafer Fab Supplier	FFAB	FFAB	FFAB
Wafer Process	ASLC10	ASLC10	LBC7

⁻ QBS: Qual By Similarity

Qualification Results

Data Displayed as: Number of lots / Total sample size / Total failed

Type	Test Name / Condition	Duration	Qual Device: SN74AVC4T245RSV R	QBS Product Reference: SN74AVC4T245PWR	QBS Product Reference: TCA6408APWR
AC	Autoclave 121C	96 hours	3/231/0	-	-
ED	Electrical Characterization	Per Datasheet Parameters	Pass	Pass	Pass
FLAM	Flammability (IEC 695-2-2)		3/15/0	-	-
FLAM	Flammability (UL 94V-0)		3/15/0	=	-
FLAM	Flammability (UL-1694)		3/15/0	-	-
HAST	Biased HAST, 130C/85%RH	96 Hours	3/231/0	=	-
HBM	ESD - HBM	3000 V	=	=	1/3/0
HBM	ESD - HBM -HIGH	8000 V	-	1/3/0	-
CDM	ESD - CDM	1500 V	-	1/3/0	1/3/0
HTOL	Life Test, 150C	300 Hours	3/231/0	-	1/77/0
HTSL	High Temp. Storage Bake, 170C	420 Hours	3/231/0	-	-
LU	Latch-up	(per JESD78)	-	1/6/0	1/6/0
PD	Physical Dimensions		3/15/0	=	-
SD	Solderability	Pb Free	3/66/0	=	-
TC	Temperature Cycle, -65/150C	500 Cycles	3/231/0	=	1/77/0
WBP	Bond Strength	Wires	3/228/0	-	-

⁻ Preconditioning was performed for Autoclave, Unbiased HAST, THB/Biased HAST, Temperature Cycle, Thermal Shock, and HTSL, as applicable

Green/Pb-free Status:

Qualified Pb-Free(SMT) and Green

⁻ Qual Devices qualified at LEVEL1-260C: SN74AVC4T245RSVR, SN74AVC4T774RSVR, TCA6408ARSVR

⁻ The following are equivalent HTOL options based on an activation energy of 0.7eV : 125C/1k Hours, 140C/480 Hours, 150C/300 Hours, and 155C/240 Hours

⁻ The following are equivalent HTSL options based on an activation energy of 0.7eV: 150C/1k Hours, and 170C/420 Hours

⁻ The following are equivalent Temp Cycle options per JESD47 : -55C/125C/700 Cycles and -65C/150C/500 Cycles Quality and Environmental data is available at Tl's external Web site: http://www.ti.com/

Qualification Report

ASEN RSW Package (Hong-how HP20VI-RH screen print)

Qualification Approved on 1/21/2016

Product Attributes

Attributes	Qual Device: TS3USB30ERSWR	QBS Package Reference: SN74AVC4T245RSVR
Assembly Site	ASEN	ASEN
Package Family	QFN	-
Flammability Rating	UL 94 V-0	UL 94 V-0
Wafer Fab Supplier	FFAB	FFAB
Wafer Process	50b10	ASLC10

- QBS: Qual By Similarity
- Qual Devices qualified at LEVEL1-260C: TS3USB30ERSWR, SN74AVC2T245RSWR

Qualification Results

Data Displayed as: Number of lots / Total sample size / Total failed

Туре	Test Name / Condition	Duration	Qual Device: TS3USB30ERSWR	QBS Package Reference: SN74AVC4T245RSVR
AC	Autoclave 121C	96 Hours	-	3/231/0
ED	Electrical Characterization	Per Datasheet Parameters	-	Pass
FLAM	Flammability (IEC 695-2-2)		-	3/15/0
FLAM	Flammability (UL 94V-0)		-	3/15/0
FLAM	Flammability (UL-1694)		-	3/15/0
HAST	Biased HAST, 130C/85%RH	96 Hours	-	3/231/0
HTOL	Life Test, 150C	300 Hours	-	3/231/0
HTSL	High Temp. Storage Bake, 170C	420 Hours	-	3/231/0
PD	Physical Dimensions		3/15/0	3/15/0
SD	Solderability	Pb Free	=	3/66/0
TC	Temperature Cycle, -65/150C	500 Cycles	-	3/231/0
WBP	Bond Strength	Wires	3/228/0	3/228/0

- Preconditioning was performed for Autoclave, Unbiased HAST, THB/Biased HAST, Temperature Cycle, Thermal Shock, and HTSL, as applicable
- The following are equivalent HTOL options based on an activation energy of 0.7eV : 125C/1k Hours, 140C/480 Hours, 150C/300 Hours, and 155C/240 Hours
- The following are equivalent HTSL options based on an activation energy of 0.7eV : 150C/1k Hours, and 170C/420 Hours
- The following are equivalent Temp Cycle options per JESD47 : -55C/125C/700 Cycles and -65C/150C/500 Cycles Quality and Environmental data is available at Tl's external Web site: http://www.ti.com/

Green/Pb-free Status:

Qualified Pb-Free(SMT) and Green

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
Japan	PCNJapanContact@list.ti.com